

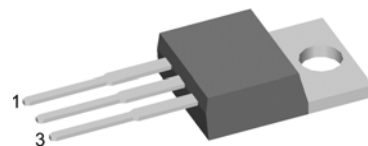
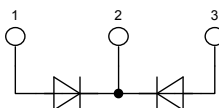
HiPerFRED²

High Performance Fast Recovery Diode
Low Loss and Soft Recovery
Common Cathode

Part number

DPG 20 C 200 PB

$$\begin{aligned} V_{RRM} &= 200 \text{ V} \\ I_{FAV} &= 2 \times 10 \text{ A} \\ t_{rr} &= 35 \text{ ns} \end{aligned}$$



Backside: cathode

Features / Advantages:

- Planar passivated chips
- Very low leakage current
- Very short recovery time
- Improved thermal behaviour
- Very low I_{rm} -values
- Very soft recovery behaviour
- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low I_{rm} reduces:
 - Power dissipation within the diode
 - Turn-on loss in the commutating switch

Applications:

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode
- Rectifiers in switch mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)

Package:

- Housing: TO-220
- Industry standard outline
- Epoxy meets UL 94V-0
- RoHS compliant

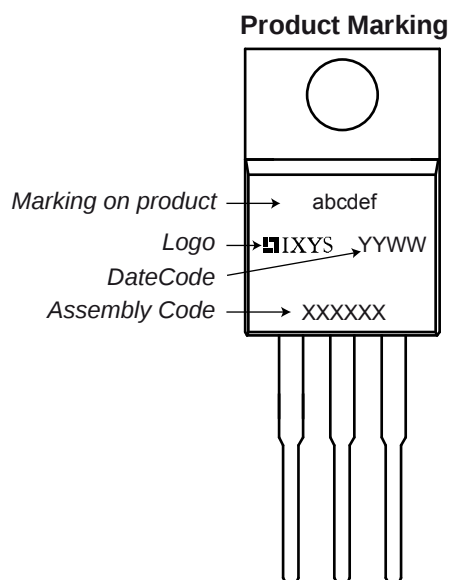
Ratings

Symbol	Definition	Conditions	min.	typ.	max.	Unit
V_{RRM}	max. repetitive reverse voltage	$T_{VJ} = 25^{\circ}\text{C}$			200	V
I_R	reverse current	$V_R = 200 \text{ V}$ $T_{VJ} = 25^{\circ}\text{C}$			1	μA
		$V_R = 200 \text{ V}$ $T_{VJ} = 150^{\circ}\text{C}$			0.06	mA
V_F	forward voltage	$I_F = 10 \text{ A}$ $T_{VJ} = 25^{\circ}\text{C}$			1.27	V
		$I_F = 20 \text{ A}$			1.45	V
		$I_F = 10 \text{ A}$ $T_{VJ} = 150^{\circ}\text{C}$			0.98	V
		$I_F = 20 \text{ A}$			1.17	V
I_{FAV}	average forward current	rectangular $d = 0.5$ $T_C = 145^{\circ}\text{C}$			10	A
V_{FO}	threshold voltage	$T_{VJ} = 175^{\circ}\text{C}$ for power loss calculation only			0.74	V
r_F	slope resistance				17.7	$\text{m}\Omega$
R_{thJC}	thermal resistance junction to case				2.30	K/W
T_{VJ}	virtual junction temperature		-55		175	$^{\circ}\text{C}$
P_{tot}	total power dissipation	$T_C = 25^{\circ}\text{C}$			65	W
I_{FSM}	max. forward surge current	$t = 10 \text{ ms}$ (50 Hz), sine $T_{VJ} = 45^{\circ}\text{C}$			140	A
I_{RM}	max. reverse recovery current	$T_{VJ} = 25^{\circ}\text{C}$		3		A
		$I_F = 10 \text{ A}; V_R = 130 \text{ V}$ $T_{VJ} = 125^{\circ}\text{C}$		5.5		A
t_{rr}	reverse recovery time	$-di_F/dt = 200 \text{ A}/\mu\text{s}$ $T_{VJ} = 25^{\circ}\text{C}$		35		ns
		$T_{VJ} = 125^{\circ}\text{C}$		45		ns
C_J	junction capacitance	$V_R = 150 \text{ V}; f = 1 \text{ MHz}$ $T_{VJ} = 25^{\circ}\text{C}$		15		pF

Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	Unit
I_{RMS}	RMS current	per pin ¹⁾			35	A
R_{thCH}	thermal resistance case to heatsink			0.50		K/W
T_{stg}	storage temperature		-55		150	°C
Weight				2		g
M_D	mounting torque		0.4		0.6	Nm
F_C	mounting force with clip		20		60	N

¹⁾ I_{RMS} is typically limited by: 1. pin-to-chip resistance; or by 2. current capability of the chip.

In case of 1, a common cathode/anode configuration and a non-isolated backside, the whole current capability can be used by connecting the backside.

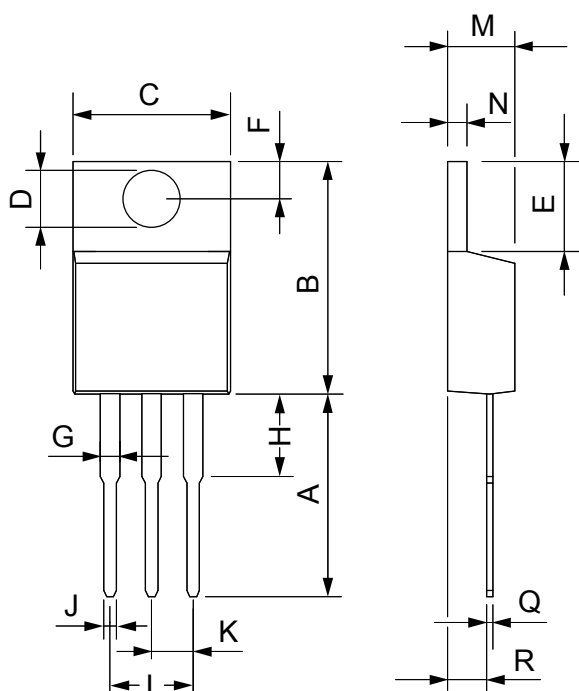


Part number

D = Diode
 P = HiPerFRED
 G = extreme fast
 20 = Current Rating [A]
 C = Common Cathode
 200 = Reverse Voltage [V]
 PB = TO-220AB (3)

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Code Key
Standard	DPG 20 C 200 PB	DPG20C200PB	Tube	50	506308

Similar Part	Package	Voltage Class
DPG20C200PN	TO-220ABFP (3)	200

Outlines TO-220


Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	12.70	13.97	0.500	0.550
B	14.73	16.00	0.580	0.630
C	9.91	10.66	0.390	0.420
D	3.54	4.08	0.139	0.161
E	5.85	6.85	0.230	0.270
F	2.54	3.18	0.100	0.125
G	1.15	1.65	0.045	0.065
H	2.79	5.84	0.110	0.230
J	0.64	1.01	0.025	0.040
K	2.54	BSC	0.100	BSC
M	4.32	4.82	0.170	0.190
N	1.14	1.39	0.045	0.055
Q	0.35	0.56	0.014	0.022
R	2.29	2.79	0.090	0.110

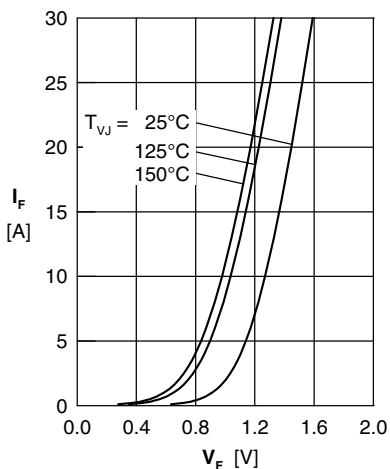


Fig. 1 Forward current I_F vs. V_F

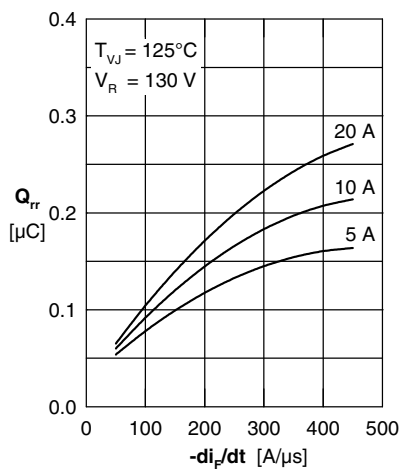


Fig. 2 Typ. reverse recovery charge Q_{rr} versus $-di_F/dt$

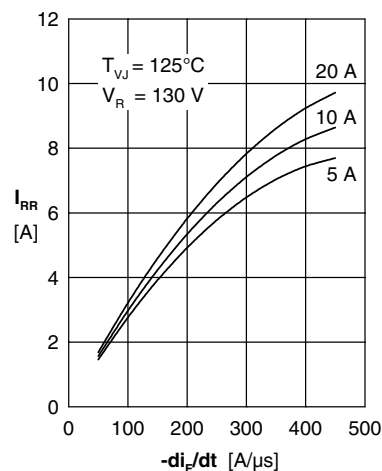


Fig. 3 Typ. peak reverse current I_{RR} versus $-di_F/dt$

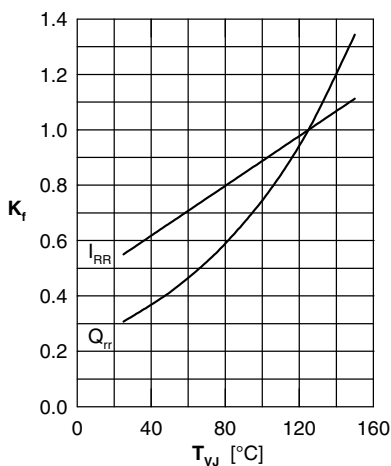


Fig. 4 Dynamic parameters Q_{rr} , I_{RR} versus T_{VJ}

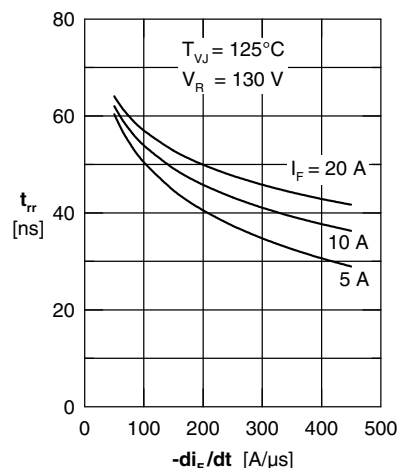


Fig. 5 Typ. recovery time t_{rr} vs. $-di_F/dt$

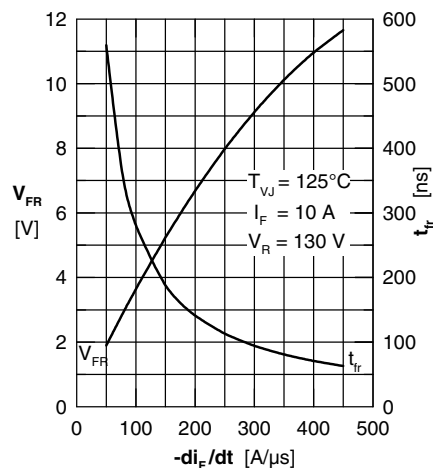


Fig. 6 Typ. peak forward voltage V_{FR} and t_{fr} versus di_F/dt

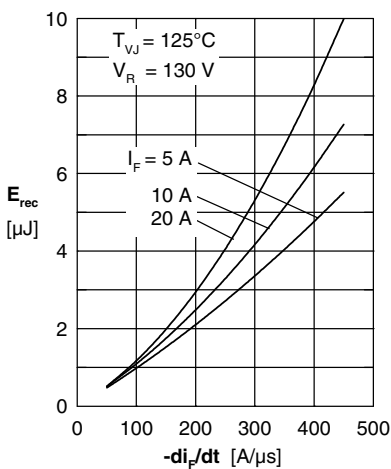


Fig. 7 Typ. recovery energy E_{rec} versus $-di_F/dt$

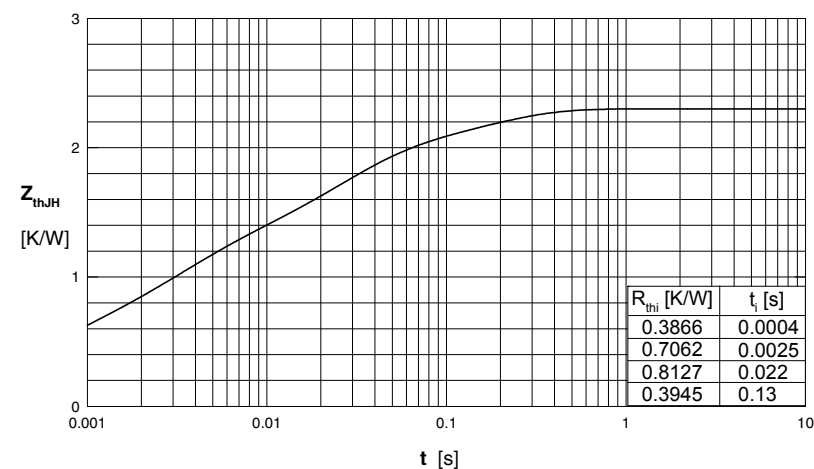


Fig. 8 Transient thermal resistance junction to case